

SiGe:C NPN RF bipolar transistor









Product description

The BFP720 is a wideband NPN RF heterojunction bipolar transistor (HBT).



Feature list

- High transition frequency f_T = 45 GHz to enable low noise figure at high frequencies: NF_{min} = 0.7 dB at 5.5 GHz, 3 V, 5 mA
- High gain G_{ma} = 19.5 dB at 5.5 GHz, 3 V, 13 mA
- OIP₃ = 23 dBm at 5.5 GHz, 3 V, 13 mA

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- · Wireless communications: WLAN, WiMax and UWB
- Satellite communication systems: GNSS navigation systems (GPS, GLONASS, BeiDou, Galileo), satellite radio (SDARs, DAB) and C-band LNB
- Multimedia applications such as portable TV, CATV and FM radio
- ISM applications like RKE, AMR and Zigbee, as well as for emerging wireless applications

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin co	nfigura	tion		Marking	Pieces / Reel
BFP720 / BFP720H6327XTSA1	SOT343	1 = B	2 = E	3 = C	4 = E	R9s	3000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

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Absolute maximum ratings

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25$ °C (unless otherwise specified)

Parameter	Symbol	Va	lues	Unit	Note or test condition	
		Min.	Max.			
Collector emitter voltage	V_{CEO}	_	4.0	٧	Open base	
			3.5		T _A = -55 °C, open base	
Collector emitter voltage	V _{CES}		13		E-B short circuited	
Collector base voltage	V_{CBO}		13		Open emitter	
Emitter base voltage	V_{EBO}		1.2		Open collector	
Base current	I _B		2	mA	_	
Collector current	Ic		25			
Total power dissipation ¹⁾	P _{tot}		100	mW	<i>T</i> _S ≤ 108 °C	
Junction temperature	TJ		150	°C	-	
Storage temperature	T_{Stg}	-55				

Attention: Stresses above the max. values listed here may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

 T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.



Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Junction - soldering point	R _{thJS}	_	420	_	K/W	-

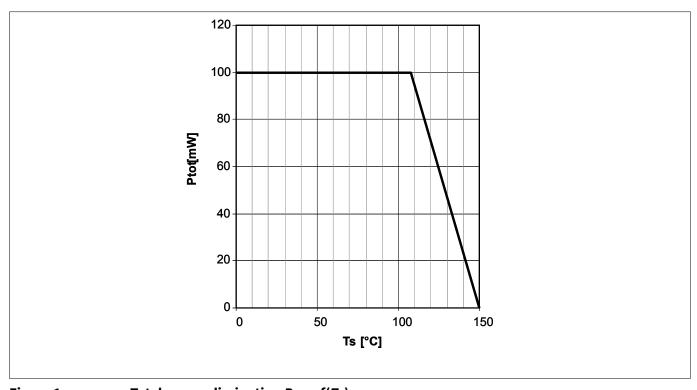


Figure 1 Total power dissipation $P_{\text{tot}} = f(T_S)$



Thermal characteristics

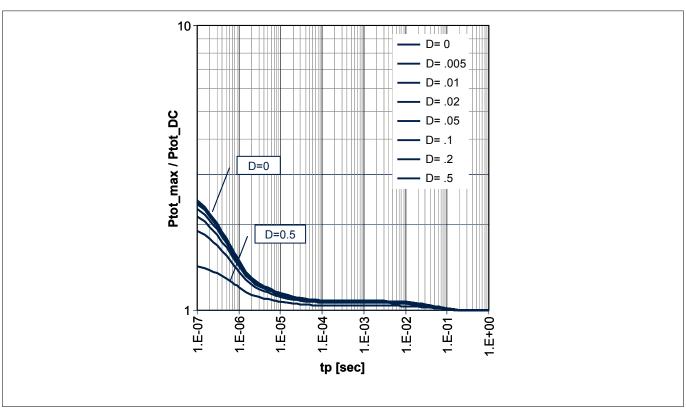


Figure 2 Permissible pulse load $P_{\text{tot, max}}/P_{\text{tot, DC}} = f(t_p)$

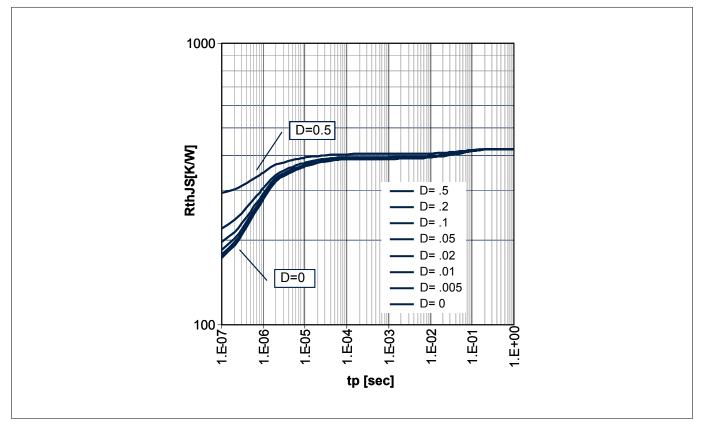


Figure 3 Permissible pulse load $R_{thJS} = f(t_p)$

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Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25$ °C

Parameter	Symbol		Values	;	Unit	Note or test condition
		Min.	Тур.	Max.		
Collector emitter breakdown voltage	V _{(BR)CEO}	4	4.7	-	V	$I_C = 1 \text{ mA}, I_B = 0,$ open base
Collector emitter leakage current	I _{CES}	_	_	30 ¹⁾	μΑ	$V_{CE} = 13 \text{ V}, V_{BE} = 0,$ E-B short circuited
Collector base leakage current	I _{CBO}			100 1)	nA	$V_{\text{CB}} = 5 \text{ V}, I_{\text{E}} = 0,$ open emitter
Emitter base leakage current	I _{EBO}			2 ¹⁾	μΑ	$V_{\rm EB}$ = 0.5 V, $I_{\rm C}$ = 0, open collector
DC current gain	h _{FE}	160	250	400		$V_{CE} = 3 \text{ V}, I_{C} = 13 \text{ mA},$ pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25$ °C

Parameter	Symbol		Values			Note or test condition
		Min.	Тур.	Мах.		
Transition frequency	f_{T}	-	45	_	GHz	$V_{CE} = 3 \text{ V}, I_{C} = 13 \text{ mA},$ f = 1 GHz
Collector base capacitance	C _{CB}		0.06		pF	$V_{CB} = 3 \text{ V}, V_{BE} = 0,$ f = 1 MHz, emitter grounded
Collector emitter capacitance	C _{CE}		0.35			$V_{CE} = 3 \text{ V}, V_{BE} = 0,$ f = 1 MHz, base grounded
Emitter base capacitance	C _{EB}		0.35			$V_{\text{EB}} = 0.5 \text{ V}, V_{\text{CB}} = 0,$ f = 1 MHz, collector grounded

¹ Maximum values not limited by the device but by the short cycle time of the 100% test.



Electrical characteristics

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, $T_{\rm A}$ = 25 °C.

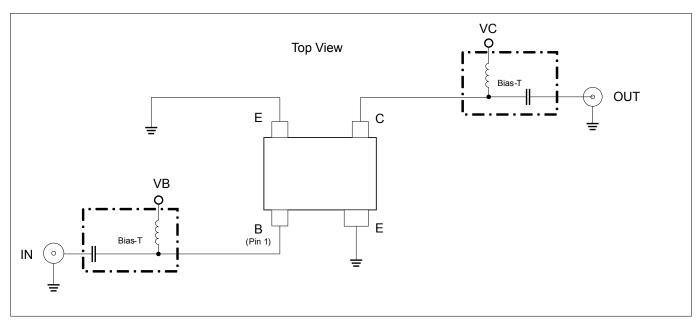


Figure 4 Testing circuit

Table 6 AC characteristics, $V_{CE} = 3 \text{ V}, f = 150 \text{ MHz}$

Parameter	ameter Symbol Values			Unit	Note or test condition	
		Min.	Тур.	Max.		
Power gain						
Maximum power gain	G _{ms}	_	37.5	_	dB	/ _C = 13 mA
• Transducer gain	$ S_{21} ^2$		29.5			
Noise figure						
Minimum noise figure	NF _{min}	_	0.4	_	dB	$I_{\rm C} = 5 \text{mA}$
Associated gain	G _{ass}		28.5			
Linearity						
3rd order intercept point at output	OIP ₃	_	22	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
$\bullet \hspace{0.5cm} 1 dB gain compression point at output$	OP _{1dB}		6			I _C = 13 mA

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Table 7 AC characteristics, $V_{CE} = 3 \text{ V}$, f = 450 MHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain						
 Maximum power gain 	G _{ms}	_	32.5	_	dB	I _C = 13 mA
Transducer gain	$ S_{21} ^2$		28.5			
Noise figure						
 Minimum noise figure 	NF _{min}	_	0.4	_	dB	$I_{\rm C} = 5 \text{mA}$
 Associated gain 	G _{ass}		28			
Linearity						
 3rd order intercept point at output 	OIP ₃	_	21.5	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		5.5			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

Table 8 AC characteristics, $V_{CE} = 3 \text{ V}, f = 900 \text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain						
 Maximum power gain 	G _{ms}	_	29.5	_	dB	I _C = 13 mA
• Transducer gain	$ S_{21} ^2$		27.5			
Noise figure						
 Minimum noise figure 	NF _{min}	_	0.4	_	dB	$I_{\rm C} = 5 \text{mA}$
Associated gain	G _{ass}		26			
Linearity						
 3rd order intercept point at output 	OIP ₃	_	21	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		5.5			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

Table 9 AC characteristics, $V_{CE} = 3 \text{ V}, f = 1.5 \text{ GHz}$

Parameter	Symbol	Values		Unit	Note or test condition	
		Min.	Тур.	Max.		
Power gain						
Maximum power gain	G _{ms}	_	27.5	_	dB	I _C = 13 mA
Transducer gain	$ S_{21} ^2$		25.5			
Noise figure						
Minimum noise figure	NF _{min}	_	0.45	_	dB	$I_{\rm C} = 5 \text{mA}$
Associated gain	G _{ass}		24			
Linearity						
3rd order intercept point at output	OIP ₃	_	21.5	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		6			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

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Electrical characteristics

Table 10 AC characteristics, $V_{CE} = 3 \text{ V}, f = 1.9 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain						
 Maximum power gain 	G _{ms}	_	26	_	dB	I _C = 13 mA
Transducer gain	$ S_{21} ^2$		24.5			
Noise figure						
 Minimum noise figure 	NF _{min}	_	0.45	_	dB	$I_{\rm C} = 5 \text{mA}$
 Associated gain 	G _{ass}		23			
Linearity						
3rd order intercept point at output	OIP ₃	_	22	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		7			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

Table 11 AC characteristics, $V_{CE} = 3 \text{ V}, f = 2.4 \text{ GHz}$

Parameter	Symbol	Values		Unit	Note or test condition	
		Min.	Тур.	Мах.		
Power gain						
Maximum power gain	G _{ms}	_	25	_	dB	I _C = 13 mA
 Transducer gain 	$ S_{21} ^2$		23			
Noise figure						
 Minimum noise figure 	NF _{min}	_	0.5	_	dB	$I_{\rm C} = 5 \text{mA}$
Associated gain	G _{ass}		21.5			
Linearity						
3rd order intercept point at output	OIP ₃	_	22	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
1 dB gain compression point at output	OP _{1dB}		6			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

Table 12 AC characteristics, $V_{CE} = 3 \text{ V}, f = 3.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Мах.		
Power gain						
 Maximum power gain 	G _{ms}	_	23.5	_	dB	$I_{\rm C} = 13 {\rm mA}$
 Transducer gain 	$ S_{21} ^2$		20			
Noise figure						
 Minimum noise figure 	NF _{min}	_	0.55	_	dB	$I_{\rm C} = 5 \rm mA$
 Associated gain 	G _{ass}		19			
Linearity						
3rd order intercept point at output	OIP ₃	_	22.5	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		7.5			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

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Table 13 AC characteristics, $V_{CE} = 3 \text{ V}, f = 5.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Мах.		
Power gain						
 Maximum power gain 	G _{ma}	_	19.5	_	dB	$I_{\rm C} = 13 {\rm mA}$
 Transducer gain 	$ S_{21} ^2$		16			
Noise figure						
 Minimum noise figure 	NF _{min}	-	0.7	-	dB	$I_{\rm C} = 5 \text{mA}$
 Associated gain 	G _{ass}		15			
Linearity						
3rd order intercept point at output	OIP ₃	_	23	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		8.5			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

Table 14 AC characteristics, $V_{CE} = 3 \text{ V}$, f = 10 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain						
 Maximum power gain 	G _{ma}	_	15	_	dB	$I_{\rm C} = 13 {\rm mA}$
 Transducer gain 	$ S_{21} ^2$		10			
Noise figure						
 Minimum noise figure 	NF _{min}	_	0.95	_	dB	$I_{\rm C} = 5 \text{mA}$
 Associated gain 	G _{ass}		10.5			
Linearity						
 3rd order intercept point at output 	OIP ₃	_	19.5	_	dBm	$Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		8			$Z_{S} = Z_{L} = 50 \Omega$ $I_{C} = 13 \text{ mA}$

Note: $G_{ms} = IS_{21}/S_{12}I$ for k < 1; $G_{ma} = IS_{21}/S_{12}I(k-(k^2-1)^{1/2})$ for k > 1. In order to get the NF_{min} values stated in this chapter the test fixture losses have been subtracted from all measured results.



Electrical characteristics

3.4 Characteristic diagrams

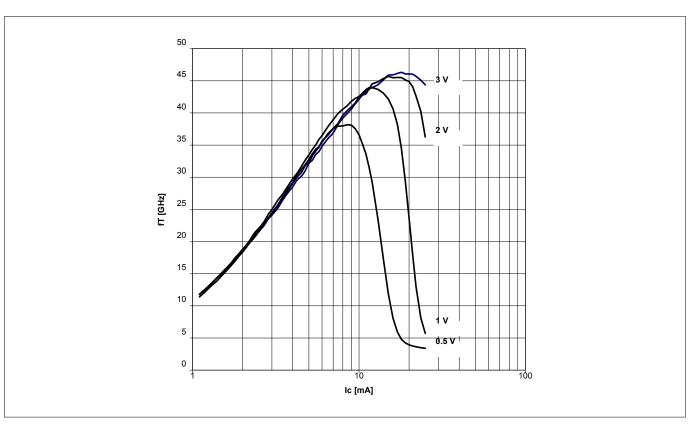


Figure 5 Transition frequency $f_T = f(I_C, V_{CE}), f = 1 \text{ GHz}, V_{CE} = \text{parameter}$

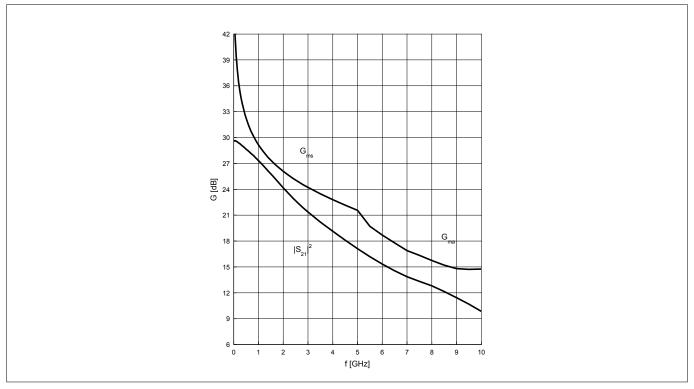


Figure 6 Power gain G_{ma} , G_{ms} , $IS_{21}I^2 = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 13 \text{ mA}$



Electrical characteristics

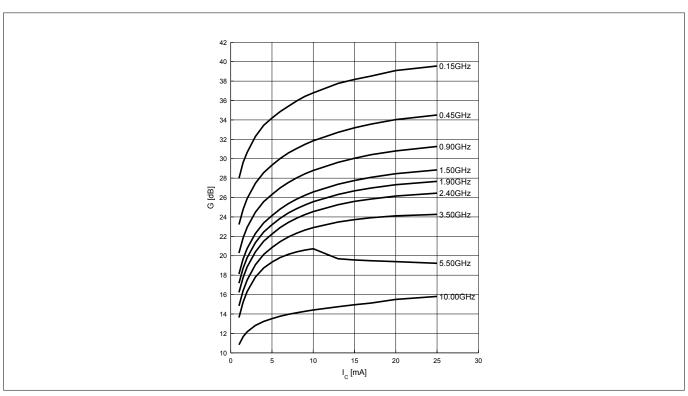


Figure 7 Power gain G_{ma} , $G_{\text{ms}} = f(I_{\text{C}})$, $V_{\text{CE}} = 3 \text{ V}$, f = Parameter in GHz

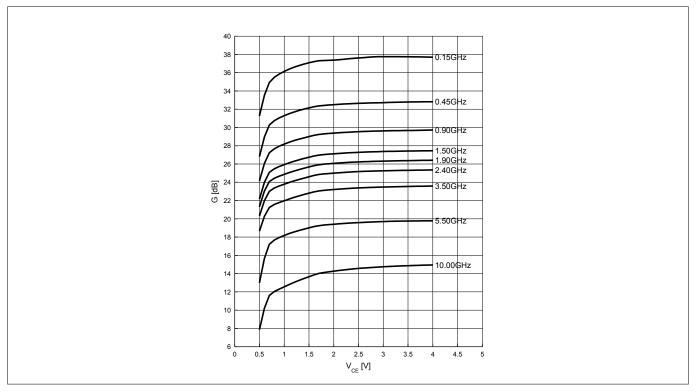


Figure 8 Power gain G_{ma} , $G_{ms} = f(V_{CE})$, $I_C = 13$ mA, f = Parameter in GHz

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Electrical characteristics

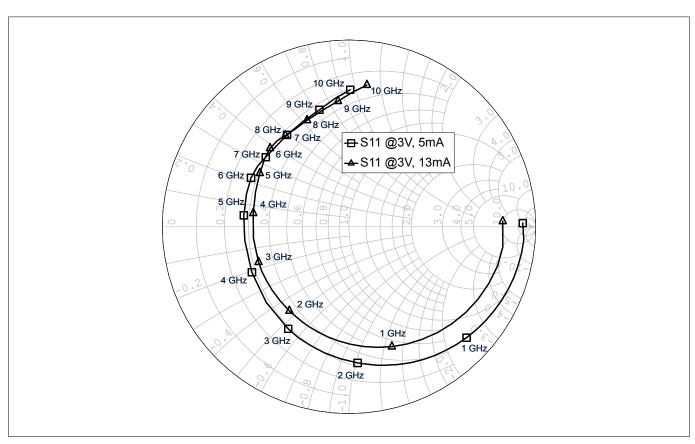


Figure 9 Input reflection coefficient $S_{11} = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 5 / 13 \text{ mA}$

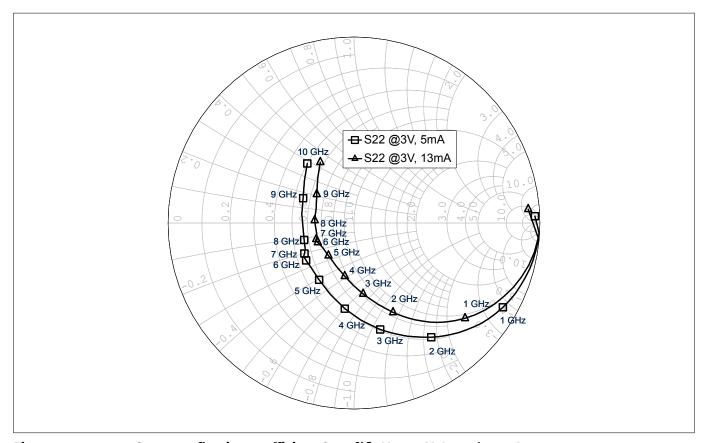


Figure 10 Output reflection coefficient $S_{22} = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 5 / 13 \text{ mA}$

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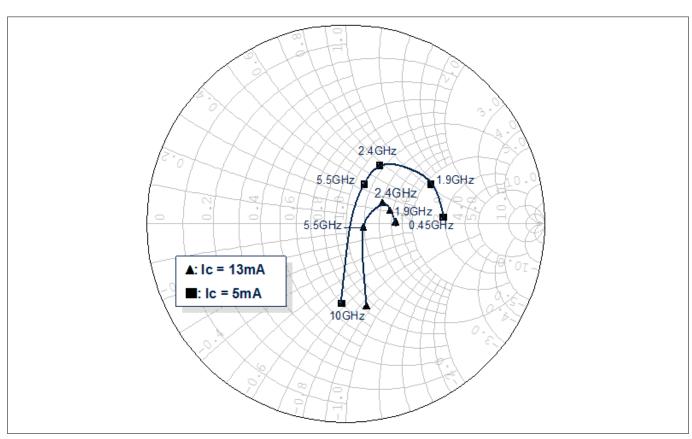


Figure 11 Source impedance for minimum noise figure $Z_{S,opt} = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 5 / 13 \text{ mA}$

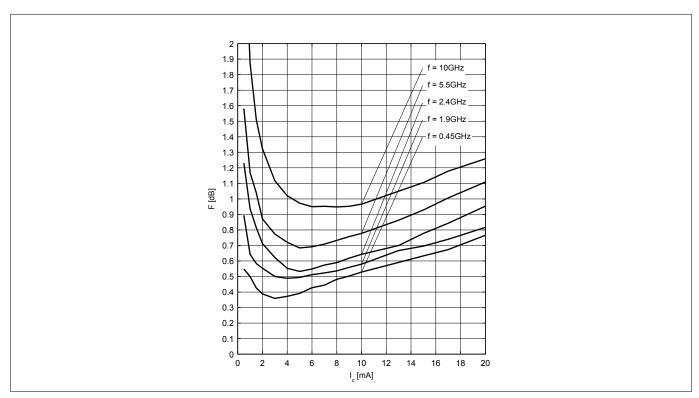


Figure 12 Noise figure $NF_{min} = f(I_C)$, $V_{CE} = 3 \text{ V}$, $Z_S = Z_{S,opt}$, f = parameter in GHz

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Electrical characteristics

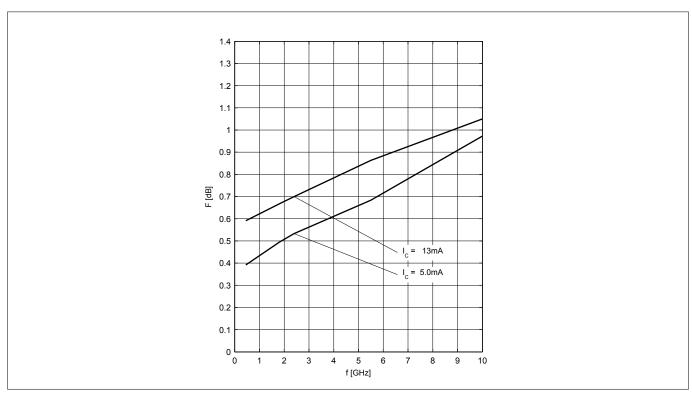


Figure 13 Noise figure $NF_{min} = f(f)$, $V_{CE} = 3 \text{ V}$, $Z_S = Z_{S,opt}$, $I_C = 5 / 13 \text{ mA}$

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25 \,^{\circ}\text{C}$.



Package information SOT343

4 Package information SOT343

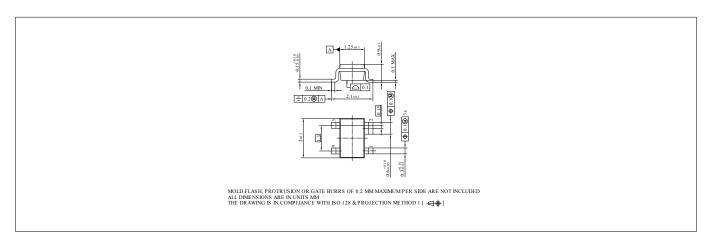


Figure 14 Package outline

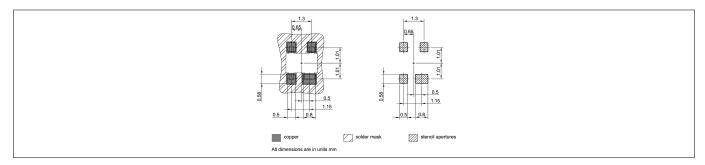


Figure 15 Foot print

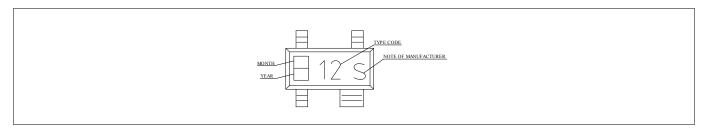


Figure 16 Marking layout example

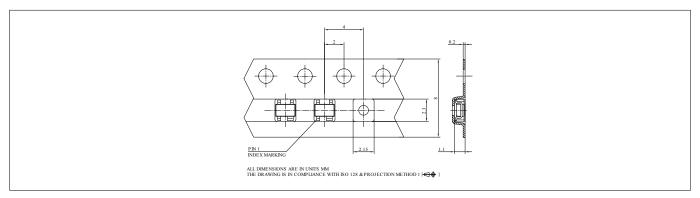


Figure 17 Tape dimensions

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Revision history

Revision history

Document version	Date of release	Description of changes
2.0	2018-09-26	New datasheet layout.

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